

# **3-Channel 20mA Linear LED Driver**

#### **Features**

- ▶ ±6% current accuracy @ 4.0 -15V
- 90V standoff voltage
- Separate enable pins for each channel allow for PWM dimming
- Over-temperature protection
- 8-Lead SOIC (w/Heat Slug) package

#### **Applications**

- LCD backlighting
- Indicator lamps

#### **General Description**

The CL320 is designed to drive 3 strings of LEDs at a constant current of 20mA.

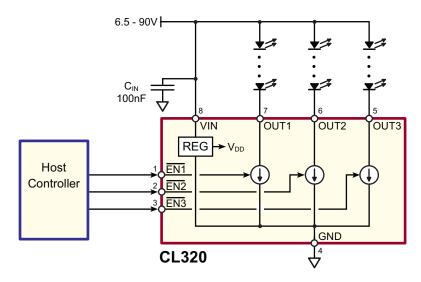
Other drivers with currents in the range of 20 - 30mA are available. The drive current is fixed, with a  $\pm 6\%$  tolerance over a V<sub>OUT</sub> range of 4 - 15V.

Separate enable pins for each channel allow for PWM dimming, 3-step linear dimming, or individual disconnection of faulty LED strings.

Over-temperature protection circuitry shuts down all 3 channels when the nominal die temperature reaches 135°C. Normal operation resumes when the die temperature drops by 30°C.

The CL320 is available in the 8-Lead SOIC (w/Heat Slug) package and requires a single ceramic bypass capacitor which may be shared among several drivers.

#### **Block Diagram and Typical Application Circuit**



## **Ordering Information**

Device	8-Lead SOIC (w/Heat Slug)
CL320	CL320SG-G
-G indicates package is RoHS comp	bliant ('Green')



## **Absolute Maximum Ratings**

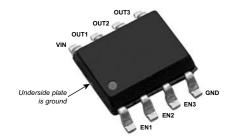
Parameter	Value
Supply voltage, V <sub>IN</sub>	-0.5V to +100V
Output voltage, V <sub>out</sub>	-0.5V to +100V
Enable voltage, V <sub>EN</sub>	-0.5V to +6.5V
Operating temperature <sup>(1)</sup>	-40°C
Storage temperature	-65°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

#### Note:

(1) Maximum junction temperature internally limited.

## **Pin Configuration**



8-Lead SOIC (w/Heat Slug) (SG)

## **Product Marking**



YY = Year Sealed WW = Week Sealed L = Lot Number \_\_\_\_\_ = "Green" Packaging

8-Lead SOIC (w/Heat Slug) (SG)

### Recommended Operating Conditions (all voltages with respect to GND pin)

Sym	Parameter	Min	Тур	Max	Units	Conditions
V <sub>IN</sub>	Supply voltage	6.5	-	90	V	
V	Output voltage	4.0	-	15	V	$\overline{EN} = 0$
V <sub>OUT</sub>				90	V	<u>EN</u> = 1
f <sub>EN</sub>	Enable toggling frequency	0	-	100	kHz	
TJ	Junction temperature	-40	-	119	°C	
C <sub>IN</sub>	V <sub>IN</sub> capacitor	-	100	-	nF	

## **Thermal Characteristics**

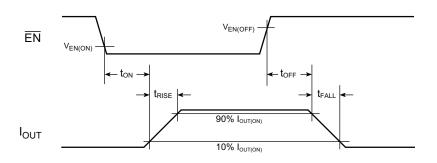
S	Sym	Parameter	Min	Тур	Max	Units	Conditions
	$\theta_{_{JA}}$	Thermal resistance, junction to ambient	-	48	-	°C/W	Mounted on JEDEC test PCB (2s 2p)
	T	Over-temperature limit	120	135	150	°C	
-	T <sub>HYS</sub>	Over-temperature hysteresis	-	30	-	°C	

#### **Electrical Characteristics**

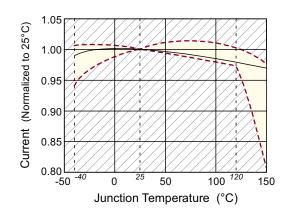
(Over recommended operating conditions.  $T_{_J}$  @ 25°C unless otherwise specified.)

Sym	Parameter	Min	Тур	Max	Units	Conditions
		-	220	250	μA	ĒN <sub>1-3</sub> = 1
I <sub>IN</sub>	V <sub>IN</sub> supply current	-	2.2	2.3	mA	ĒN <sub>1-3</sub> = 0
I <sub>OUT(OFF)</sub>	Output current, off	-	4.0	10	μA	$\overline{EN}_{x} = 1$
		-	-	21.2		$\overline{EN}_{x} = 0, V_{OUT} = 0 - 4.0V$
I <sub>OUT(ON)</sub>	Output current, on	18.8	20.0	21.2	mA	ĒN <sub>x</sub> = 0, V <sub>out</sub> = 4.0 - 15V
		18.0	20.0	22.0		ĒN <sub>x</sub> = 0, V <sub>out</sub> = 15 - 90V
V <sub>EN(ON)</sub>	Enable voltage, on	-	-	0.8	V	
V <sub>EN(OFF)</sub>	Enable voltage, off	2.4	-	-	V	
C <sub>EN</sub>	Enable input capacitance	-	5.0	10	pF	
I <sub>ENL</sub>	Enable low input current	-	-	1.0	μA	$V_{EN} = 0V$
I <sub>ENH</sub>	Enable high input current		-	1.0	μA	V <sub>EN</sub> = 5.0V
t <sub>on</sub>	Enable on delay	-	2.0	2.4	μs	
t <sub>RISE</sub>	Output current rise time	-	1.0	1.2	μs	
t <sub>off</sub>	Enable off delay	-	440	800	ns	
t <sub>FALL</sub>	Output current fall time	-	170	250	ns	

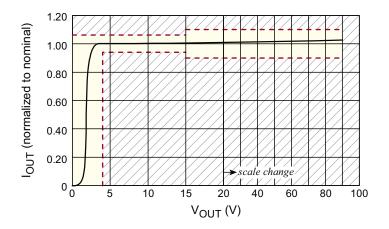
## Timing



### **Temperature Effects**



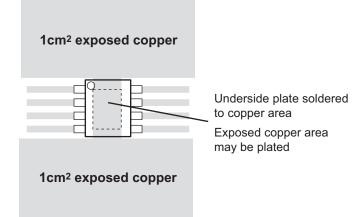
### **Load Regulation**



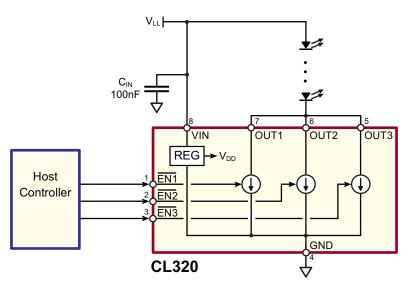
## **Pin Description**

Pin #	Name	Description
1,2,3	ĒN1, ĒN2, ĒN3	Output enable, active low.
4	GND	Circuit common.
5,6,7	OUT1, OUT2, OUT3	Constant current output (sinking). Connect the cathodes of the LEDs to these pins.
8	VIN	Supply voltage. 6.5V to 90V. Bypass locally with a 100nF capacitor to ground.
Underside Plate	GND	The exposed underside plate is internally connected to the GND pin. The plate may either be left floating or connected to ground. Solder the plate to an exposed copper area on the PCB for heatsinking purposes (see recommended layout).

## **Recommended PCB Layout**

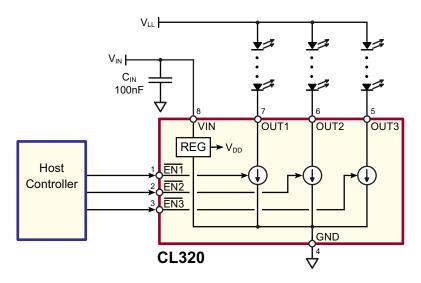


### **Higher LED Current**

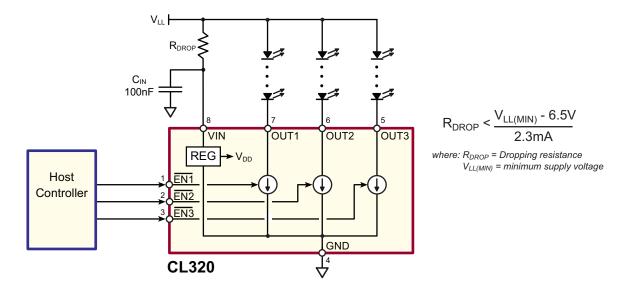


By paralleling outputs, higher LED currents can be achieved. In addition, linear dimming in 3 discrete steps may be obtained by enabling 1, 2, or 3 outputs.

## Lowering CL320 Power Dissipation: Separate V<sub>IN</sub> Supply

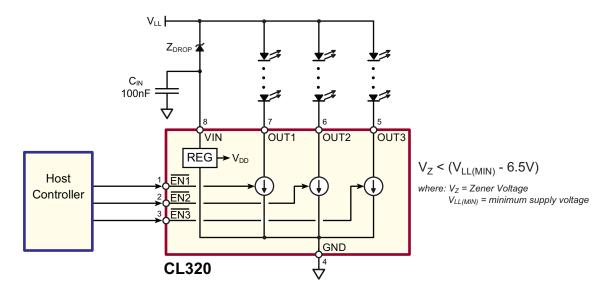


CL320 power dissipation may be lowered by supplying the CL320 from a voltage source ( $V_{IN}$ ) that is lower in voltage than the LED supply ( $V_{LL}$ ).

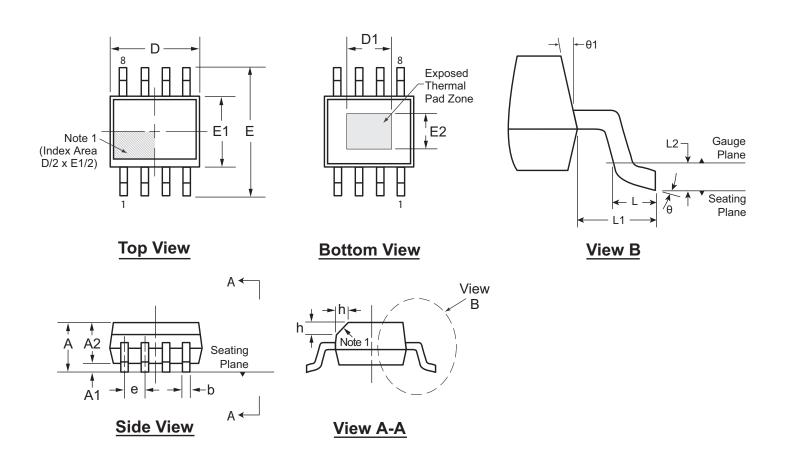


#### Lowering CL320 Power Dissipation: Dropping Resistor

Lowering CL320 Power Dissipation: Zener Diode



## 8-Lead SOIC (w/Heat Slug) Package Outline (SG) 4.90x3.90mm body, 1.70mm height (max), 1.27mm pitch



#### Note 1:

This chamfer feature is optional. If it is not present, then a Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier may be either a mold, or an embedded metal or marked feature.

Symbo	ol	Α	A1	A2	b	D	D1	Е	E1	E2	е	h	L	L1	L2	θ	θ1
Dimension (mm)	MIN	1.25	0.00	1.25	0.31	4.80	3.30*	5.80	3.80	2.29*		0.25	0.40			<b>0</b> 0	5°
	NOM	-	-	-	-	4.90	-	6.00	3.90	-	1.27 BSC - 0.50	-		0.25 BSC	-	-	
	MAX	1.70	0.15	1.70	0.51	5.00	3.81*	6.20	4.00	2.79*		0.50	1.27		630	<b>8</b> 0	15 <sup>0</sup>

JEDEC Registration MS-012, Variation BA, Issue E, Sept. 2005.

Dimensions marked with (\*) are non-JEDEC dimensions.

Drawings not to scale.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <u>http://www.supertex.com/packaging.html</u>.)

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